

Product Specification – Mar. 24, 2004 V.4 Supersedes Date of Feb. 10, 2004



DATA SHEET

CHIP RESISTORS ARRAY TC164 (8Pin/4R) 5%







Chip Resistor Surface Mount TC SERIES 164

<u>SCOPE</u>

This specification describes TC164 series chip resistors made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing style, temperature coefficient, special type and resistance value.

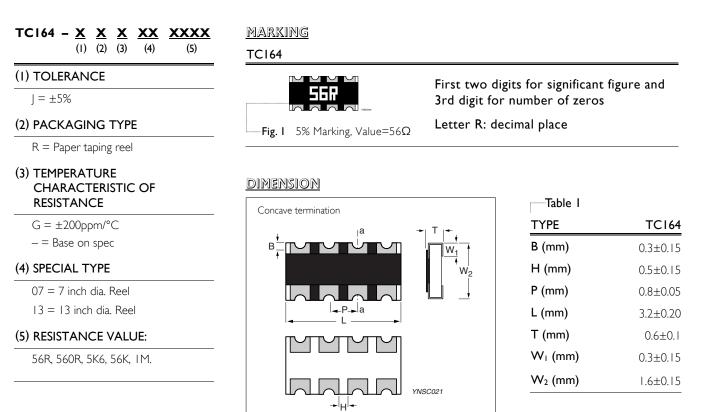
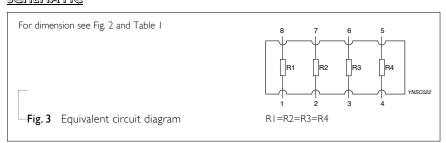


Fig. 2 TCI64 series chip resistors construction

SCHEMATIC



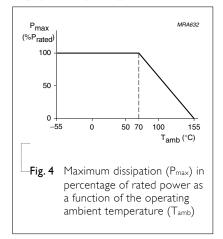
Mar. 24, 2004 V.4 Downloaded from <u>Elcodis.com</u> electronic components distributor



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POWER RATING

RATED POWER AT 70°C, TC164 =1/16W FOR ELEMENT



RATED VOLTAGE:

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V=\sqrt{(P X R)}$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)

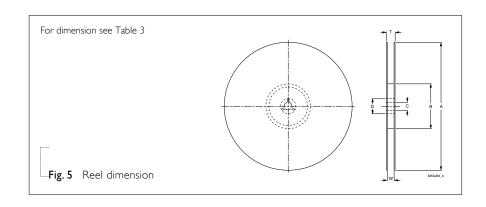
ELECTRICAL CHARACTERISTICS

Table 2	
CHARACTERISTICS	TC164 1/16W
Operating Temperature Range	–55°C to +155°C
Maximum Working Voltage	50V
Maximum Overload Voltage	100V
Dielectric Withstanding Voltage	100∨
Number of Resistors	4
Resistance Range	10Ω to 1MΩ Zero Ohm Jumper <0.05Ω
Temperature Coefficient	±200ppm/°C
Jumper Criteria	Rated Current I.0A
	Maximum Current 2.0A

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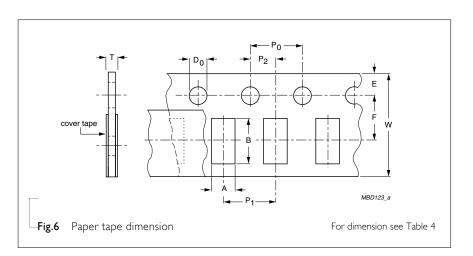
<u>TAPING REEL</u>

Table 3	
DIMENSION	TCI64
Tape Width	8mm
ØA (mm)	180+0/-3
ØB (mm)	60+1/_0
ØC (mm)	13.0±0.2
ØD (mm)	21±0.8
W (mm)	9.0±0.3
T (mm)	.4±



PAPER TAPE SPECIFICATION

Table 4	
DIMENSION	TC164
A (mm)	2.0±0.1
B (mm)	3.5±0.1
W (mm)	8.0±0.2
E (mm)	1.75±0.1
F (mm)	3.5±0.05
P ₀ (mm)	4.0±0.1
P ₁ (mm)	4.0±0.1
P ₂ (mm)	2.0±0.05
ØD₀ (mm)	1.5+0.1/-0
T (mm)	0.85±0.1



PACKING METHOD

LEADER/TRAILER TAPE SPECIFICATION

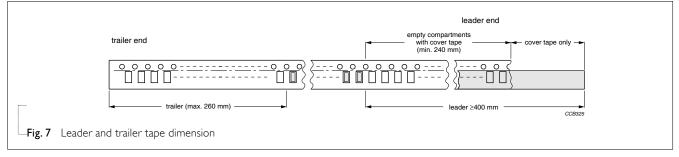


Table 5 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	TC164
Paper Taping Reel (R)	7" (178 mm)	5,000
	13" (330 mm)	20,000

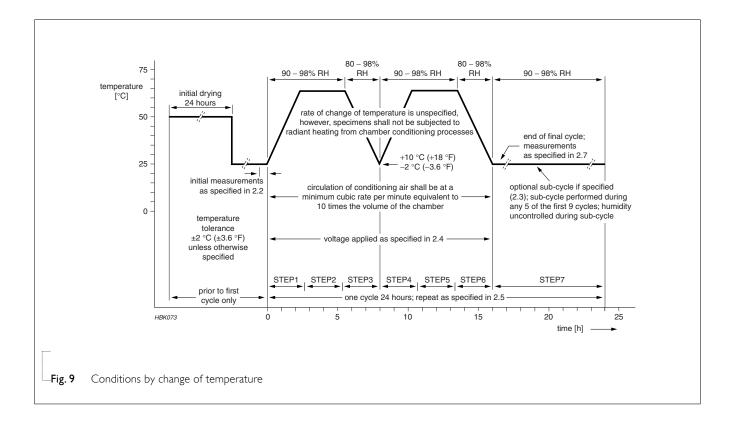
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ГҮРЕ	TEST METHOD				ACCEPTANCE STANDARD
Temperature	Measure resistance at Formula		Refer to table 2		
Coefficient of Resistance (T.C.R.)	+155°C respectively as R ₂ . Determine the	Where t1=+25°C or spec t2=-55°C or +155 R1=resistance at re	C.R. = $\frac{R_2-R_1}{R_1(t_2-t_1)}$ × 10 ⁶ (ppm/°C) "here =+25°C or specified room temperature =-55°C or +155°C test temperature =resistance at reference temperature in ohms =resistance at test temperature in ohms		
Thermal Shock	At $-55\pm3^{\circ}$ C for 2 minutes and at $+155\pm2^{\circ}$ C for 2 minutes as one cycle. After 5 cycles, the specimen shall be stabilized at room temp. Measure the resistance to determine Δ R/R(%) after one more hour.			±(1.0%+0.05Ω)	
Low Temperature Operation	Place the specimen in a test chamber maintained at –65 (+0/–5)°C. After one hour stabilization at this temperature, full rated working voltage shall be applied for 45 (+5/–0) minutes. Have15 (+5/–0) minutes after remove the voltage, the specimen shall be removed from the chamber and stabilized at room temperature for 24 hrs. Measure the resistance to determine $\Delta R/R(\%)$.			±(1.0%+0.05Ω) No visible damage	
Short Time Overload	Apply 2.5 times of rated voltage but not exceeding the maximum overload voltage for 5 seconds. Have the specimen stabilized at room temperature for 30 minutes minimum. Measure the resistance to determine $\Delta R/R(\%)$.		±(2.0%+0.05Ω) No visible damage		
Insulation Resistance	Place the specimen in the jig a continues overload voltage (R. minute as shown. Measure the insulation resistan	C.O.V) for one	Type Voltage (DC)	TC164	≥I0,000MΩ
Dielectric Withstand Voltage	Place the specimen in the jig a specified value continuous ove shown for one minute.		Type Voltage (AC)	TC164	Breakdown voltage> specification and without open/short
Resistance To Soldering Heat	Immerse the specimen in the s specimen stabilized at room te Measure the resistance to dete	emperature for 30 r		s. Have the	±(1.0%+0.05Ω) No visible damage

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TYPE	TEST METHOD		ACCEPTANCE STANDARD
Moisture Resistance	Place the specimen in the test chamber and sub one of which consists of the steps 1 to 7 as figu- hours. Have the specimen stabilized at room te Measure the resistance to determine Δ R/R(%)	±(2.0%+0.05Ω) No visible damage	
Life	Place the specimen in the oven at 70±2°C. App at the 1.5 hours on and 0.5 hour off cycle. The Have the specimen stabilized at room tempera- testing. Measure the $\Delta R/R(\%)$.	±(3.0%+0.1Ω) No visible damage	
Solderability	Immerse the specimen in the solder pot at $235\pm5^{\circ}$ C for 5 sec.		At least 95% solder coverage on the termination
Bending Strength	Mount the specimen on a test board as shown in the figure 8. Slowly apply the force till the board is bent for 5 ± 1 sec. Measure the $\Delta R/R(\%)$ at this position.	TypeTC164Bent Distance (d)Imm	±(1.0%+0.05Ω) No visible damage

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